ITEM NO.: AP120-13-016W-3



■説明:

- ●鋁合金材質_AL1050
- ●UL 認證案號 E234220
- ●符合 ROHS 規範
- ●使用 CREE MX6 發光源

注意:静電気対策を行いお取り扱いください 警告:直視すると眼を傷めることがあります PRECAUTIONS -THE DIRECTLIGHT CAUSE INJURIES TO HUMAN EYES. -AS THE PRODUCTS ARE SUSCEPTIBLE TO STATIC ELECTRICITY. THE UTMOST CARE MUST BE TAKEN WHEN HANDLING THEM.

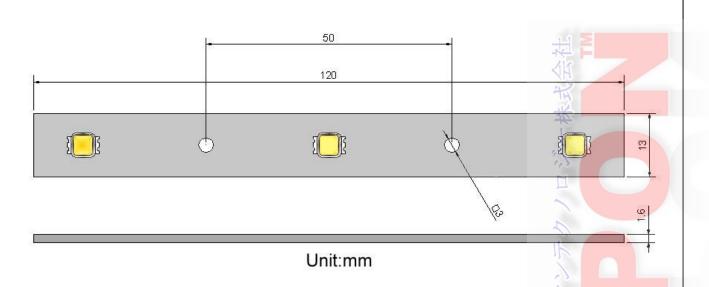


外觀加工成型示意:





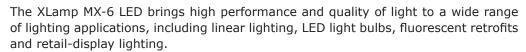
■外觀尺寸: Unit: mm±0.1





Cree® XLamp® MX-6 LEDs Data Sheet

The Cree XLamp MX-6 LED provides the proven lighting-class performance and reliability of Cree XLamp LEDs in a flat-top PLCC package. The XLamp MX-6 LED continues Cree's history of innovation in LEDs for lighting applications with wide viewing angle, unlimited floor life, uniform light output without secondary optics and electrically neutral thermal path.





FEATURES

- Available in white (2,600 K to 8,300 K CCT)
- Maximum drive current: 350 mA
- Wide viewing angle: 120°
- Electrically neutral thermal path
- Qualification at max drive current
- RoHS-compliant
- Unlimited floor life at ≤ 30°C/85% RH

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Flux Characteristics $(T_1 = 25^{\circ}C)$

The following table provides several base order codes for XLamp MX-6 LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp MX-6 LED Binning and Labeling document.

Color	CCT Range		Base Order Codes Min Luminous Flux (Im) @ 300 mA		Calculated Min Luminous Flux (lm) @ 350 mA*	Order Code	
	Min.	Max.	Group	Flux (lm)	Flux (lm)		
Cool White	5,000 K	8,300 K	Q4	100	114	MX6AWT-A1-0000-000C51	
			Q5	107	122	MX6AWT-A1-0000-000D51	
Warm White	3,700 K	4,300 K	Q3	93.9	107	MX6AWT-A1-0000-000BE5	
	2,900 K	3,200 K	P4	80.6	92	MX6AWT-A1-0000-0009E7	

^{*} Calculated values for reference purposes only.

Notes:

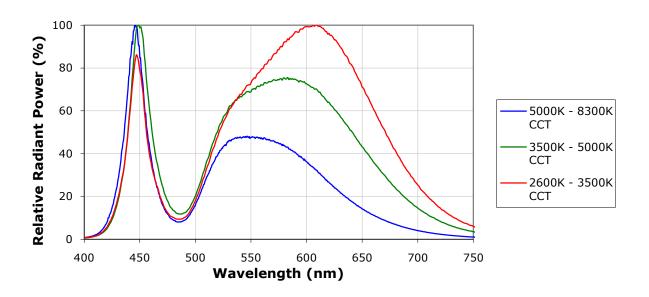
- Cree maintains a tolerance of +/- 7% on flux measurements.
- Typical CRI for Cool White (4,300 K 8,300 K CCT) is 75.
- Typical CRI for Warm White (2,600 K 4,300 K CCT) is 80.

Characteristics

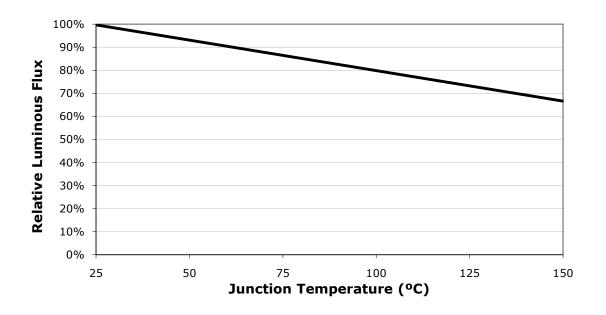
Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point	°C/W		5	
Viewing angle (FWHM)	degrees		120	
Temperature coefficient of voltage	mV/°C		-3.3	
ESD classification (HBM per Mil-Std-883D)			Class 2	
DC forward current	mA			350
Forward voltage (@ 300 mA)	V		3.3	3.8
LED junction temperature	°C			150



Relative Spectral Power Distribution

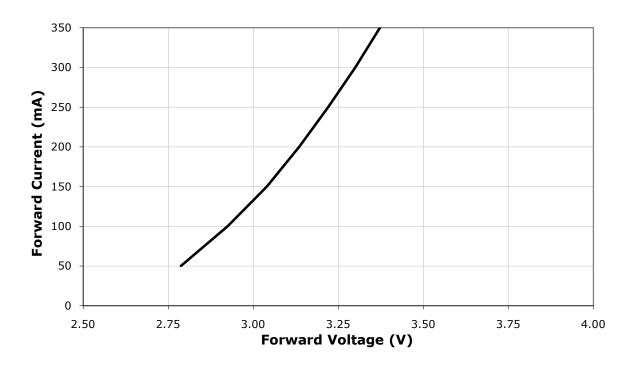


Relative Flux vs. Junction Temperature ($I_F = 300 \text{ mA}$)

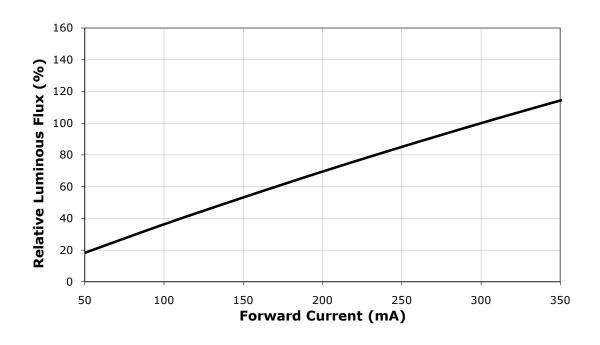




Electrical Characteristics (T₁ = 25°C)



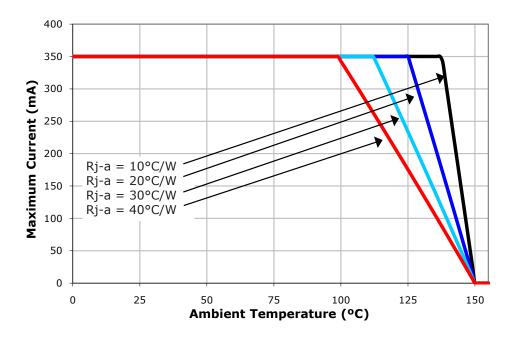
Relative Flux vs. Current $(T_1 = 25^{\circ}C)$



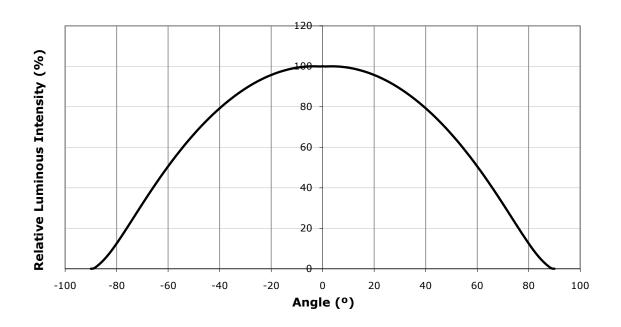


Thermal Design

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.



Typical Spatial Distribution

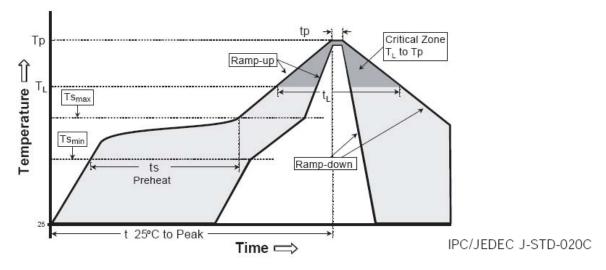




Reflow Soldering Characteristics

In testing, Cree has found XLamp MX-6 LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



Profile Feature	Lead-Based Solder	Lead-Free Solder
Average Ramp-Up Rate (Ts _{max} to Tp)	3°C/second max.	3°C/second max.
Preheat: Temperature Min (Ts _{min})	100°C	150°C
Preheat: Temperature Max (Ts _{max})	150°C	200°C
Preheat: Time (ts _{min} to ts _{max})	60-120 seconds	60-180 seconds
Time Maintained Above: Temperature (T _L)	183°C	217°C
Time Maintained Above: Time (t _L)	60-150 seconds	60-150 seconds
Peak/Classification Temperature (Tp)	215°C	260°C
Time Within 5°C of Actual Peak Temperature (tp)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6°C/second max.	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.



Notes

Moisture Sensitivity

In testing, Cree has found XLamp MX-6 LEDs to have unlimited floor life in conditions $\leq 30^{\circ}$ C / 85% relative humidity (RH). Moisture testing included a 168 hour soak at 85°C / 85% RH followed by 3 reflow cycles, with visual and electrical inspections at each stage.

RoHS Compliance

The levels of environmentally sensitive, persistent biologically toxic (PBT), persistent organic pollutants (POP), or otherwise restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2002/95/EC on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS), as amended through April 21, 2006.

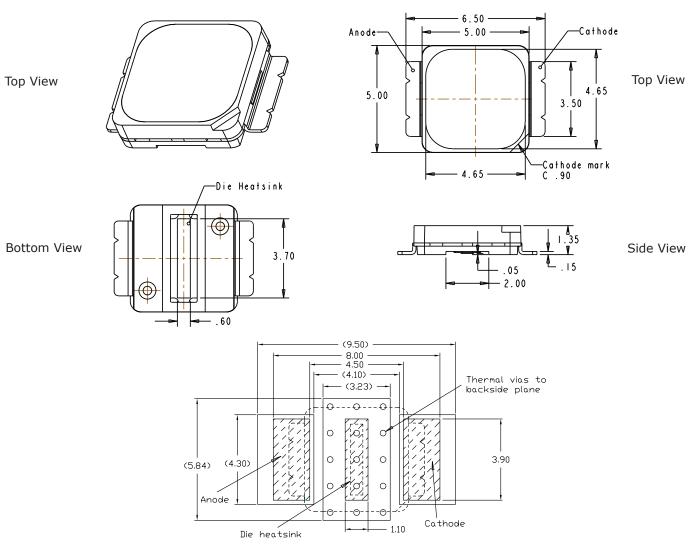
Vision Advisory Claim

Users should be cautioned not to stare at the light of this LED product. The bright light can damage the eye.

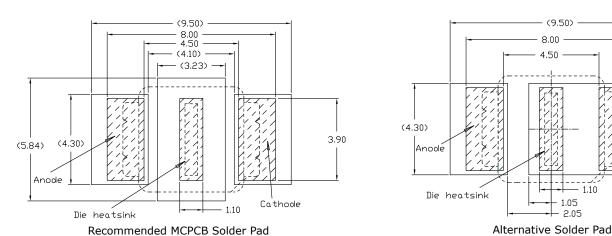


Mechanical Dimensions $(T_A = 25^{\circ}C)$

All measurements are ±.13 mm unless otherwise indicated.



Recommended FR4 Solder Pad



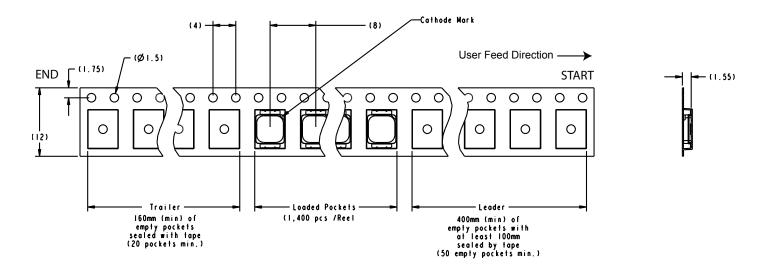
Cathode

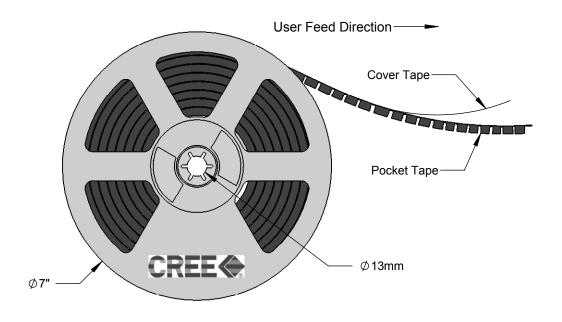
3.90



Tape and Reel

All dimensions in mm.







Packaging

All dimensions in mm.

